

# Global Semiconductor Packaging and Assembly Equipment Market Professional Survey Report 2016

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## Abstracts

### Notes:

Production, means the output of Semiconductor Packaging and Assembly Equipment

Revenue, means the sales value of Semiconductor Packaging and Assembly Equipment

This report studies Semiconductor Packaging and Assembly Equipment in Global market, especially in North America, Europe, China, Japan, Southeast Asia and India, with production, revenue, consumption, import and export in these regions, from 2011 to 2015, and forecast to 2021.

This report focuses on top manufacturers in global market, with production, price, revenue and market share for each manufacturer, covering

Applied Materials

ASM Pacific Technology (ASMPT)

Disco

EV Group (EVG)

Kulicke and Soffa Industries

Tokyo Electron Ltd. (TEL)

Tokyo Seimitsu

Rudolph Technologies

SEMES

Suss Microtec

By types, the market can be split into

Die-level packaging and assembly equipment

Wafer-level packaging and assembly equipment

Type III

By Application, the market can be split into

Application 1

Application 2

Application 3

By Regions, this report covers (we can add the regions/countries as you want)

North America

China

Europe

Southeast Asia

Japan

India

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